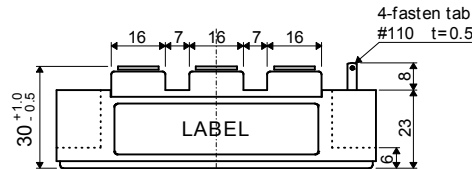
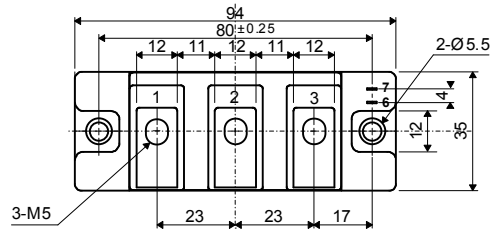
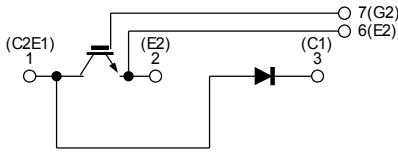


□ 回路図 : **CIRCUIT**

□ 外形寸法図 : **OUTLINE DRAWING**



Dimension: [mm]

□ **最大定格 : MAXIMUM RATINGS** (at  $T_c=25^\circ\text{C}$  unless otherwise specified)

Item	Symbol	Rated Value	Unit
コレクタ・エミッタ間電圧 Collector-Emitter Voltage	$V_{CES}$	600	V
ゲート・エミッタ間電圧 Gate-Emitter Voltage	$V_{GES}$	±20	V
コレクタ電流 Collector Current	DC	150	A
	1ms	300	
コレクタ損失 Collector Power Dissipation	$P_C$	560	W
接合温度 Junction Temperature Range	$T_j$	-40~+150	°C
保存温度 Storage Temperature Range	$T_{stg}$	-40~+125	°C
絶縁耐圧 (Terminal to Base AC, 1minute) Isolation Voltage	$V_{iso}$	2,500	V (RMS)
締め付けトルク Mounting Torque	Module Base to Heatsink	2 (20.4)	N·m (kgf·cm)
	Busbar to Main Terminal		

□ **電気的特性 : ELECTRICAL CHARACTERISTICS** (at  $T_j=25^\circ\text{C}$  unless otherwise specified)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
コレクタ遮断電流 Collector-Emitter Cut-Off Current	$I_{CES}$	$V_{CE} = 600V, V_{GE} = 0V$	-	-	1.0	mA
ゲート漏れ電流 Gate-Emitter Leakage Current	$I_{GES}$	$V_{GE} = \pm 20V, V_{CE} = 0V$	-	-	1.0	μA
コレクタ・エミッタ間飽和電圧 Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C = 150A, V_{GE} = 15V$	-	2.1	2.6	V
ゲートしきい値電圧 Gate-Emitter Threshold Voltage	$V_{GE(th)}$	$V_{CE} = 5V, I_C = 150mA$	4.0	-	8.0	V
入力容量 Input Capacitance	$C_{ies}$	$V_{CE} = 10V, V_{GE} = 0V, f = 1MHz$	-	7,500	-	pF
スイッチング時間 Switching Time	上昇時間 Rise Time	$V_{CC} = 300V$ $R_L = 2.0\Omega$ $R_G = 5.1\Omega$ $V_{GE} = \pm 15V$	-	0.15	0.30	μs
	ターンオン時間 Turn-on Time		-	0.25	0.40	
	下降時間 Fall Time		-	0.10	0.35	
	ターンオフ時間 Turn-off Time		-	0.35	0.70	

□ **フリーホイーリングダイオードの特性 : FREE WHEELING DIODE RATINGS & CHARACTERISTICS** (at  $T_c=25^\circ\text{C}$ ) & **CHARACTERISTICS** (at  $T_j=25^\circ\text{C}$ )

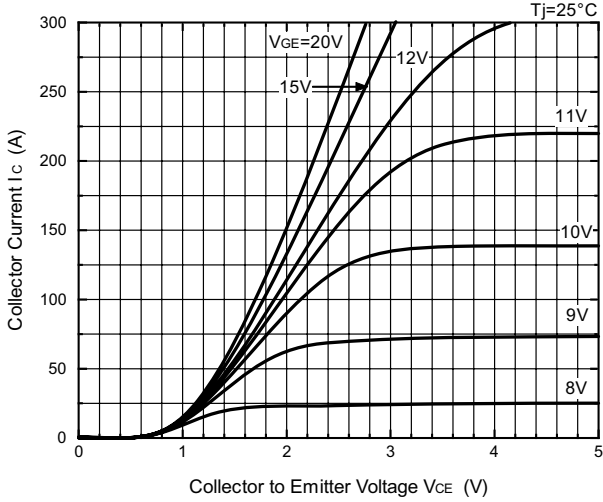
Item	Symbol	Rated Value	Unit
順電流 Forward Current	DC	150	A
	1ms	300	

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
順電圧 Peak Forward Voltage	$V_F$	$I_F = 150A, V_{GE} = 0V$	-	1.9	2.4	V
逆回復時間 Reverse Recovery Time	$t_{rr}$	$I_F = 150A, V_{GE} = -10V$ $di/dt = 300A/\mu s$	-	0.15	0.25	μs

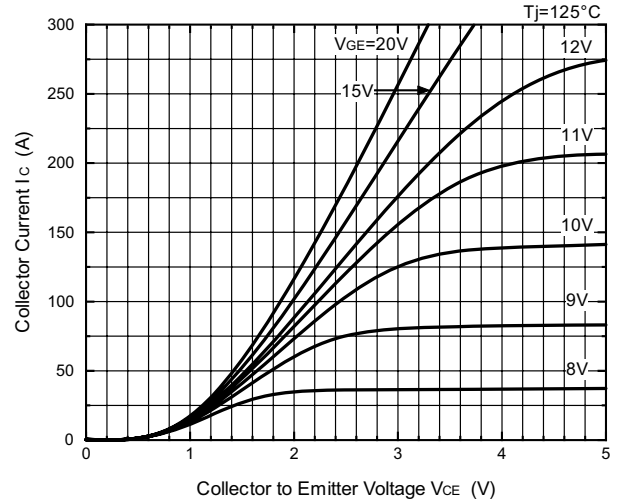
□ **熱的特性 : THERMAL CHARACTERISTICS**

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
熱抵抗 Thermal Impedance	IGBT	Junction to Case ( $T_c$ チップ直下での測定点)	-	-	0.22	°C/W
	Diode		-	-	0.45	

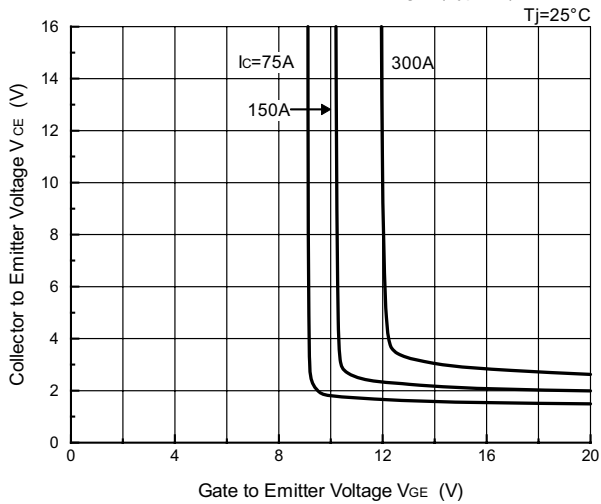
**Fig.1- Output Characteristics (Typical)**



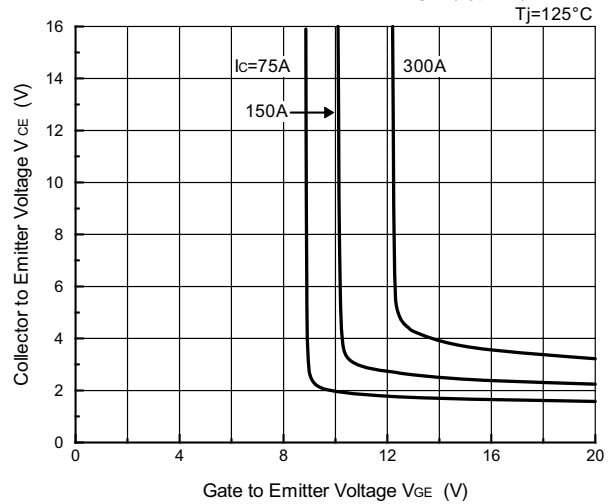
**Fig.2- Output Characteristics (Typical)**



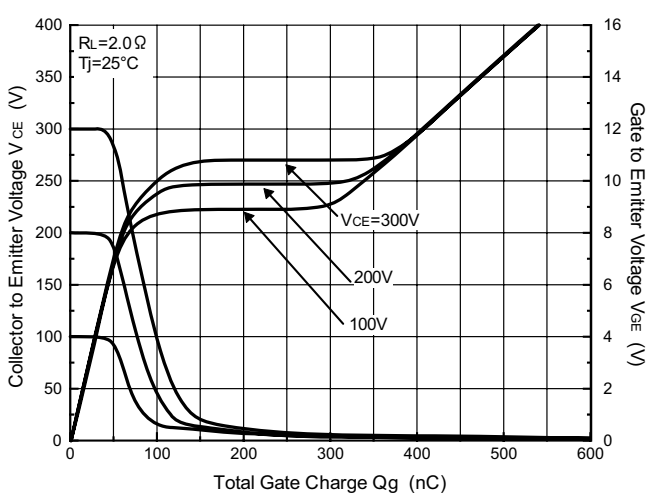
**Fig.3- Collector to Emitter On Voltage vs. Gate to Emitter Voltage (Typical)**



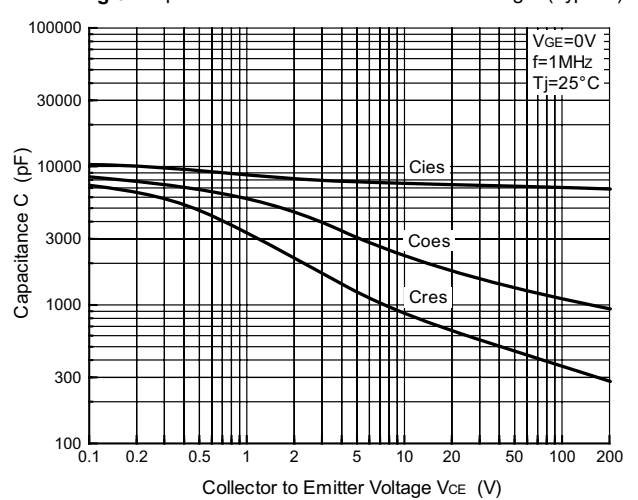
**Fig.4- Collector to Emitter On Voltage vs. Gate to Emitter Voltage (Typical)**



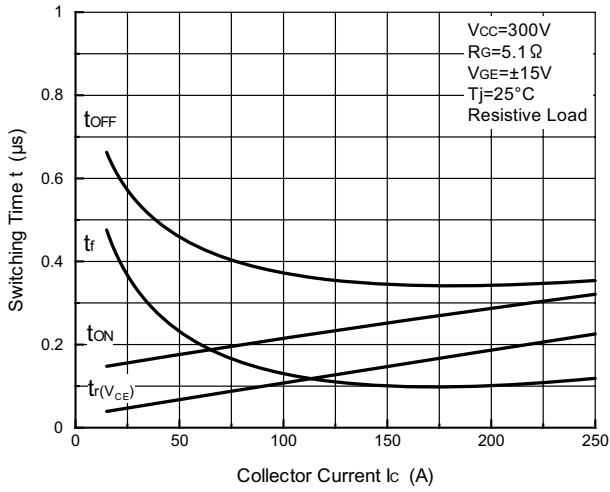
**Fig.5- Gate Charge vs. Collector to Emitter Voltage (Typical)**



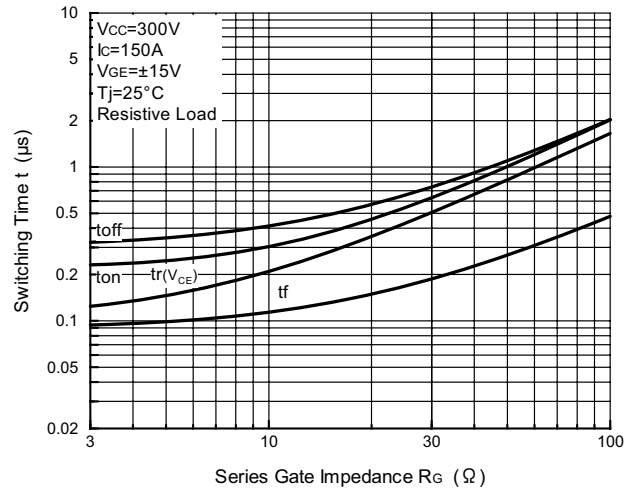
**Fig.6- Capacitance vs. Collector to Emitter Voltage (Typical)**



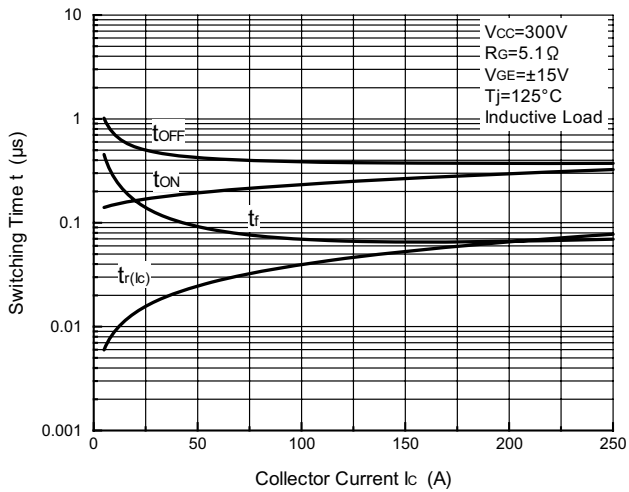
**Fig.7- Collector Current vs. Switching Time (Typical)**



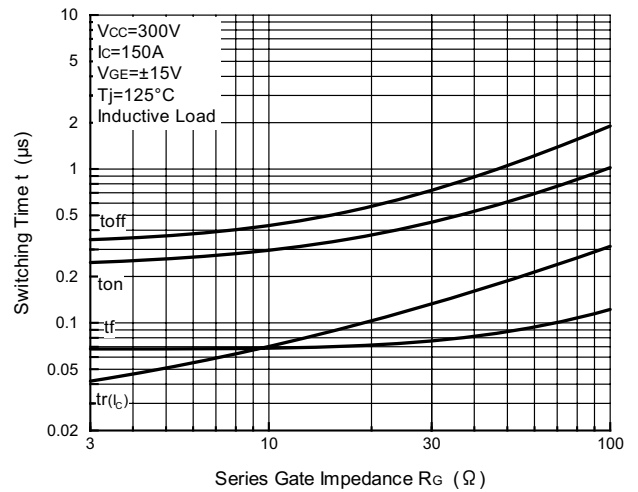
**Fig.8- Series Gate Impedance vs. Switching Time (Typical)**



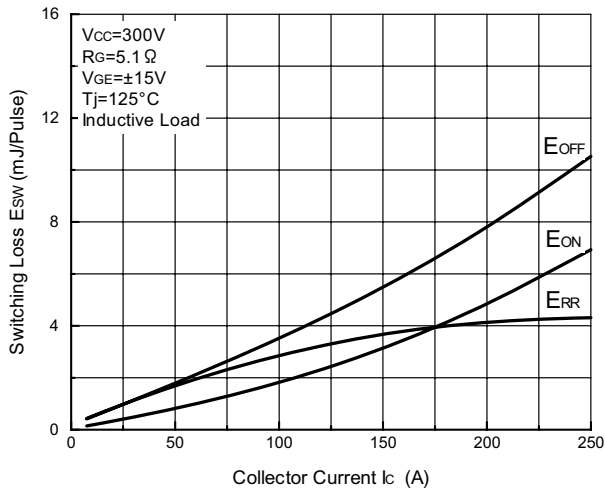
**Fig.9- Collector Current vs. Switching Time**



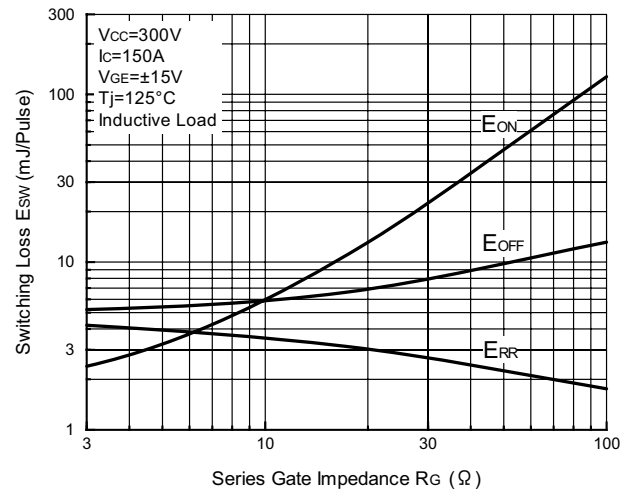
**Fig.10- Series Gate Impedance vs. Switching Time**



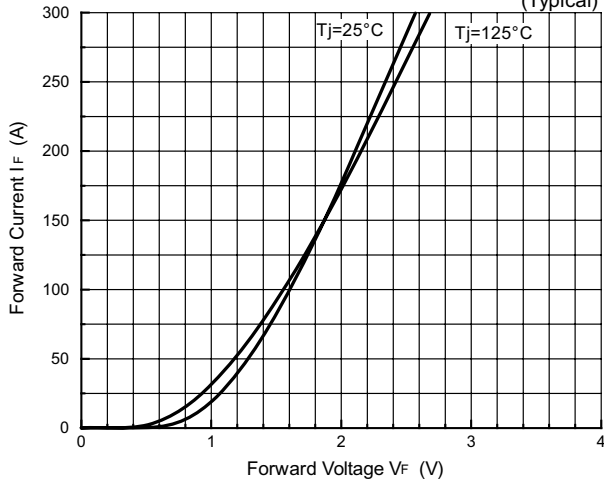
**Fig.11- Collector Current vs. Switching Loss**



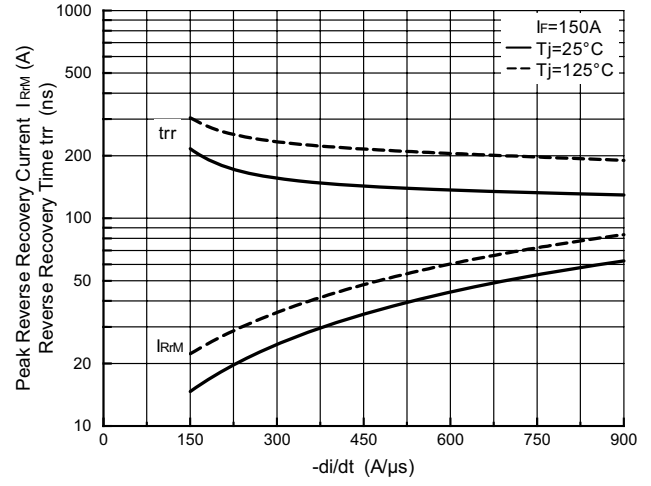
**Fig.12- Series Gate Impedance vs. Switching Loss**



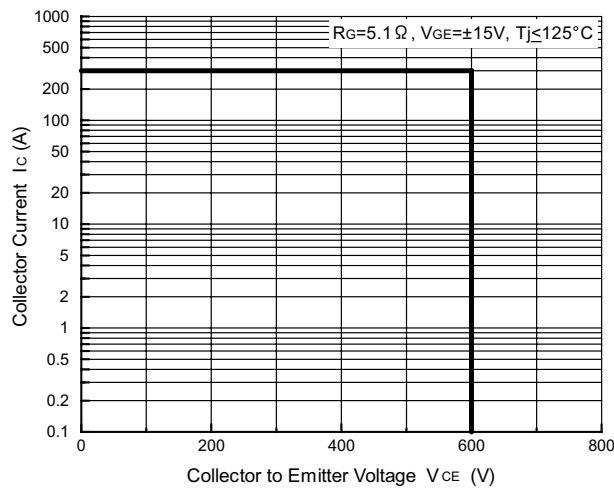
**Fig.13- Forward Characteristics of Free Wheeling Diode (Typical)**



**Fig.14- Reverse Recovery Characteristics (Typical)**



**Fig.15- Reverse Bias Safe Operating Area**



**Fig.16- Transient Thermal Impedance**

